



# Secondary Side Post Regulator for AC/DC and DC/DC Multiple Output Converters

## Description

The CS-5101 is a bipolar monolithic secondary side post regulator (SSPR) which provides tight regulation of multiple output voltages in AC-DC or DC-DC converters. Leading edge pulse width modulation is used with the CS-5101.

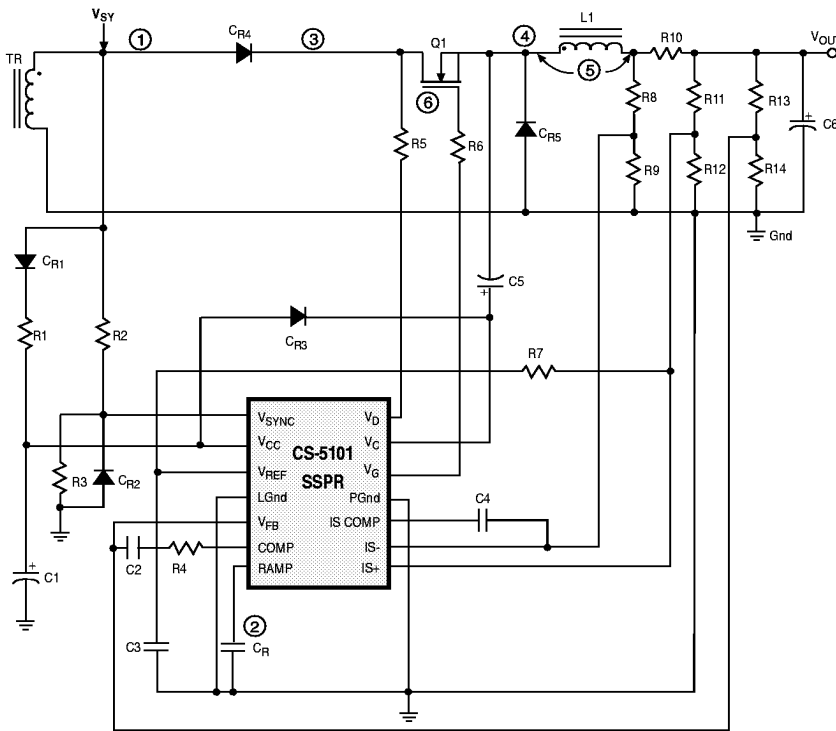
The CS-5101 is designed to operate over an 8V to 45V supply voltage ( $V_{CC}$ ) range and up to a 75V drive voltage ( $V_C$ ).

The CS-5101 features include a totem pole output with 1.5A peak output current capability, externally programmable overcurrent protection, an on chip 2% precision 5V reference, internally compensated error amplifier, externally synchronized switching frequency, and a power switch drain voltage monitor. It is available in a 14 lead plastic DIP or a 16 lead wide body SO package.

## Features

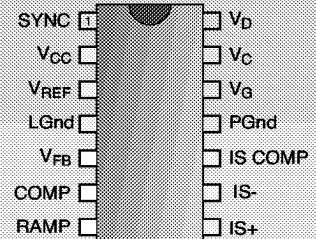
- 1.5A Peak Output (Grounded Totem Pole)
- 8V to 75V Gate Drive Voltage
- 8V to 45V Supply Voltage
- 300ns Propagation Delay
- 1% Error Amplifier Reference Voltage
- Lossless Turn On and Turn Off
- Sleep Mode:  $< 100\mu A$
- Overcurrent Protection with Dedicated Differential Amp
- Synchronization to External Clock
- External Power Switch Drain Voltage Monitor

## Application Diagram

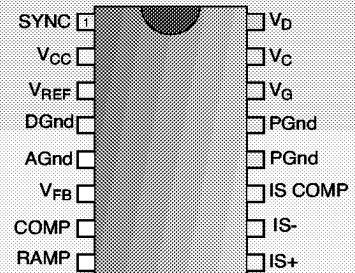


## Package Options

### 14L PDIP



### 16L SO Wide



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### Absolute Maximum Ratings

Power Supply Voltage, $V_{CC}$ .....	-0.3V to 45V
$V_{SYNC}$ and Output Supply Voltages, $V_C$ , $V_G$ , $V_{SYNC}$ , $V_D$ .....	-0.3V to 75V
$V_{IS+}$ , $V_{IS-}$ ( $V_{CC} - 4V$ , up to 24V) .....	-0.3 to 24V
$V_{REF}$ , $V_{FB}$ , $V_{COMP}$ , $V_{RAMP}$ , $V_{ISCOMP}$ .....	-0.3 to 10V
Operating Junction Temperature, $T_J$ .....	-40 to 150°C
Operating Temperature Range .....	-40 to 85°C
Storage Temperature Range .....	-65 to 150°C
Output Energy (capacitive load per cycle) .....	5 $\mu$ J
ESD Human Body .....	2kV
ESD Machine Model .....	200V
Lead Temperature Soldering	
Wave Solder (through hole styles only) .....	10 sec. max, 260°C peak
Reflow (SMD styles only) .....	60 sec. max above 183°C, 230°C peak

**Electrical Characteristics:  $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ ;  $-40^{\circ}\text{C} \leq T_J \leq 150^{\circ}\text{C}$ ;  $10\text{V} < V_{CC} < 45\text{V}$ ;  $8\text{V} < V_C < 75\text{V}$  unless otherwise specified.**

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>■ Error Amplifier</b>					
Input Voltage Initial Accuracy	$V_{FB} = V_{COMP}$ ; $V_{CC} = 15\text{V}$ ; $T = 25^{\circ}\text{C}$ (Note 1)	1.98	2.00	2.02	V
Input Voltage	$V_{FB} = V_{COMP}$ , includes line and temp	1.94	2.00	2.06	V
Input Bias Current	$V_{FB} = 0\text{V}$ ; $I_{V_{FB}}$ flows out of pin			500	nA
Open Loop Gain	$1.5\text{V} < V_{COMP} < 3.0\text{V}$	60	70		dB
Unity Gain Bandwidth	$1.5\text{V} < V_{COMP} < 3.0\text{V}$ ; (Note 1)	0.7	1.0		MHz
Output Sink Current	$V_{COMP} = 2.0\text{V}$ ; $V_{FB} = 2.2\text{V}$	2	8		mA
Output Source Current	$V_{COMP} = 2.0\text{V}$ ; $V_{FB} = 1.8\text{V}$	2	6		mA
$V_{COMP}$ High	$V_{FB} = 1.8\text{V}$	3.3	3.5	3.7	V
$V_{COMP}$ Low	$V_{FB} = 2.2\text{V}$	0.85	1.0	1.15	V
PSRR	$10\text{V} < V_{CC} < 45\text{V}$ ; $V_{FB} = V_{COMP}$ (Note 1)	60	70		dB
<b>■ Voltage Reference</b>					
Output Voltage Initial Accuracy	$V_{CC} = 15\text{V}$ ; $T = 25^{\circ}\text{C}$ (Note 1)	4.9	5.0	5.1	V
Output Voltage	$0\text{A} < I_{REF} < 8\text{mA}$	4.8	5.0	5.2	V
Line Regulation	$10\text{V} < V_{CC} < 45\text{V}$ ; $I_{REF} = 0\text{A}$		10	60	mV
Load Regulation	$0\text{A} < I_{REF} < 8\text{mA}$		20	60	mV
Current Limit	$V_{REF} = 4.8\text{V}$	10	50		mA
$V_{REF\_OK}$ FAULT V	$V_{SYNC} = 5\text{V}$ ; $V_{REF} = V_{LOAD}$	4.10	4.40	4.60	V
$V_{REF\_OK}$ V	$V_{SYNC} = 5\text{V}$ ; $V_{REF} = V_{LOAD}$	4.30	4.50	4.80	V
$V_{REF\_OK}$ Hysteresis		40	100	250	mV
<b>■ Current Sense Amplifier</b>					
IS COMP High V	$IS^+ = 5\text{V}$ ; $IS^- = IS\ COMP$	4.7	5.0	5.3	V
IS COMP Low V	$IS^+ = 0\text{V}$ ; $IS^- = IS\ COMP$	0.5	1.0	1.3	V
Source Current	$IS^+ = 5\text{V}$ ; $IS^- = 0\text{V}$	2.0	10		mA
Sink Current	$IS^- = 5\text{V}$ ; $IS^+ = 0\text{V}$	10	20		mA
Open Loop Gain	$1.5\text{V} \leq V_{COMP} \leq 4.5\text{V}$ ; $R_L = 4\text{k}\Omega$	60	80		dB
CMRR	(Note 1)	60	80		dB
PSRR	$10\text{V} < V_{CC} < 45\text{V}$ , (Note 1)	60	80		dB
Unity Gain Bandwidth	$1.5\text{V} \leq V_{COMP} \leq 4.5\text{V}$ ; $R_L = 4\text{k}\Omega$ (Note 1)	0.5	0.8		MHz

## Electrical Characteristics: continued

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>■ Current Sense Amplifier: continued</b>					
Input Offset Voltage	$V_{IS^+} = 2.5V; V_{IS^-} = V_{ISCOMP}$	-8	0	8	mV
Input Bias Currents	$V_{IS^+} = V_{IS^-} = 0V; I_{IS}$ flows out of pins		20	250	nA
Input Offset Current ( $IS^+, IS^-$ )		-250	0	250	nA
Input Signal Voltage Range	(Note 1)	-0.3		$V_{CC}-4.0$	V
<b>■ RAMP/SYNC Generator</b>					
Ramp Source Current Initial Accuracy	$V_{SYNC} = 5V; V_{RAMP} = 2.5V; T = 25^\circ C$ (Note 1)	0.18	0.20	0.22	mA
Ramp Source Current	$V_{SYNC} = 5V; V_{RAMP} = 2.5V$	0.16	0.20	0.24	mA
Ramp Sink Current	$V_{SYNC} = 0V; V_{RAMP} = 2.5V$	1.0	4.0		mA
RAMP Peak Voltage	$V_{SYNC} = 5V$	3.3	3.5	3.7	V
RAMP Valley Voltage	$V_{SYNC} = 0V$	1.4	1.5	1.6	V
RAMP Dynamic Range	$V_{RAMPDR} = V_{RAMP PK} - V_{RAMP VY}$	1.7	2.0	2.3	V
RAMP Sleep Threshold Voltage	$V_{RAMP} @ V_{REF} < 2.0V$	0.3	0.6	1.0	V
SYNC Threshold	$V_{SYNC} @ V_{RAMP} > 2.5V$	2.3	2.5	2.7	V
SYNC Input Bias Current	$V_{SYNC} = 0V; I_{SYNC}$ flows out of pin		1	20	$\mu A$
<b>■ Output Stage</b>					
$V_G$ High	$V_{SYNC} = 5V; I_{V_G} = 200mA; V_C - V_G$		1.6	2.5	V
$V_G$ Low	$V_{SYNC} = 0V; I_{V_G} = 200mA$		0.9	1.5	V
$V_G$ Rise Time	Switch $V_{SYNC}$ High; $C_G = 1nF$ ; $V_{CC} = 15V$ ; measure 2V to 8V		30	75	ns
$V_G$ Fall Time	Switch $V_{SYNC}$ Low; $C_G = 1nF$ ; $V_{CC} = 15V$ ; measure 8V to 2V		40	100	ns
$V_G$ Resistance to Gnd	Remove supplies; $V_G = 10V$		50	100	k $\Omega$
$V_D$ Resistance to Gnd	Remove supplies; $V_D = 10V$	500	1500		$\Omega$
<b>■ General</b>					
$I_{CC}$ Operating	$V_{SYNC} = 5V$		12	18	mA
$I_{CC}$ in UVL	$V_{CC} = 6V$		300	500	$\mu A$
$I_{CC}$ in Sleep Mode High	$V_{RAMP} = 0V; V_{CC} = 45V$		80	200	$\mu A$
$I_{CC}$ in Sleep Mode Low	$V_{RAMP} = 0V; V_{CC} = 10V$		20	50	$\mu A$
$I_C$ Operating High	$V_{SYNC} = 5V; V_{FB} = V_{IS^-} = 0V$ ; $V_C = 75V$		4	8	mA
$I_C$ Operating Low	$V_{SYNC} = 5V; V_{FB} = V_{IS^-} = 0V; V_C = 8V$		3	6	mA
UVLO Start Voltage		7.4	8.0	9.2	V
UVLO Stop Voltage		6.4	7.0	8.3	V
UVLO Hysteresis		0.8	1.0	1.2	V
Leading Edge, $t_{DELAY}$	$V_{SYNC} = 2.5V$ to $V_G = 8V$		280		ns
Trailing Edge, $t_{DELAY}$	$V_{SYNC} = 2.5V$ to $V_G = 2V$		750		ns

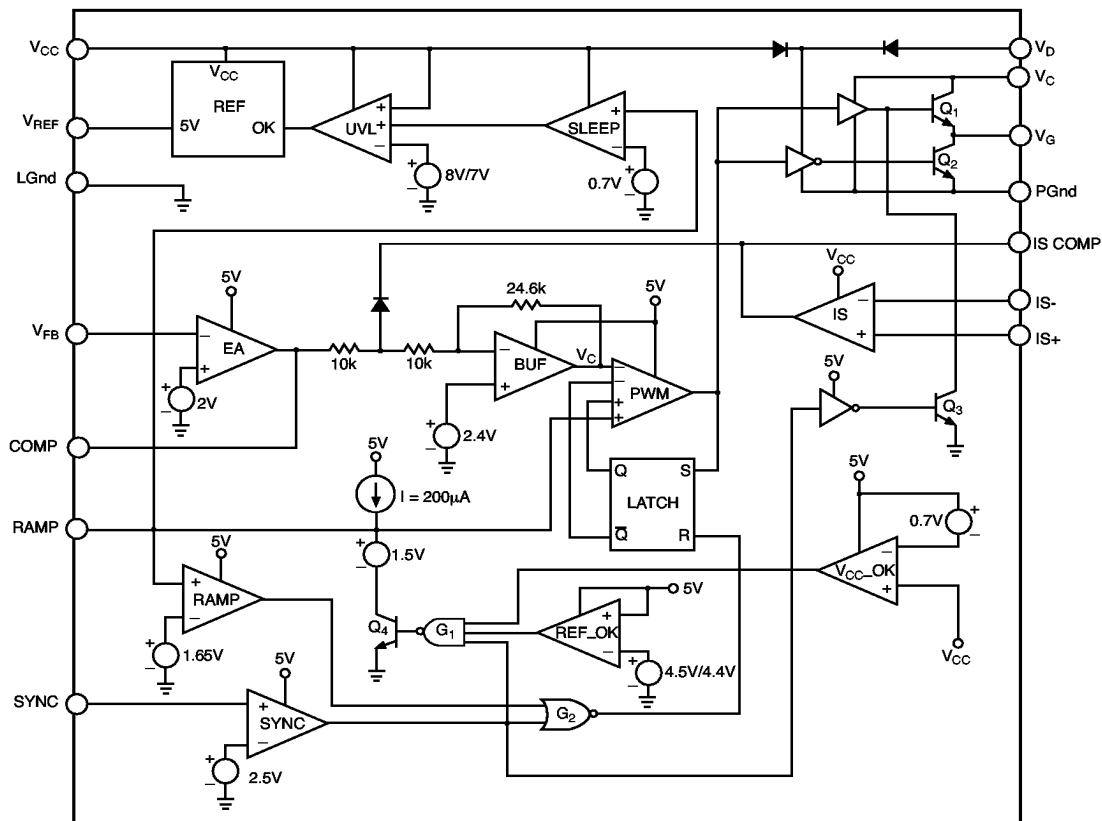
Note 1: Guaranteed by design. Not 100% tested in production.

## Package Pin Description

PACKAGE PIN #		PIN SYMBOL	FUNCTION
14L PDIP	16L SO Wide		
1	1	SYNC	Synchronization input.
2	2	V <sub>CC</sub>	Logic supply (10V to 45V).
3	3	V <sub>REF</sub>	5.0V voltage reference.
4		LGnd	Logic level ground (Analog and digital ground tied).
5	6	V <sub>FB</sub>	Error amplifier inverting input.
6	7	COMP	Error amplifier output and compensation.
7	8	RAMP	RAMP programmable with the external capacitor.
8	9	IS+	Current sense amplifier non-inverting input.
9	10	IS-	Current sense amplifier inverting input.
10	11	IS COMP	Current sense amplifier compensation and output.
11	12, 13	PGnd	Power ground.
12	14	V <sub>G</sub>	External power switch gate drive.
13	15	V <sub>C</sub>	Output power stage supply voltage (8V to 75V).
14	16	V <sub>D</sub>	External FET DRAIN Voltage Monitor.
	5	AGnd	Analog Ground.
	4	DGnd	Digital Ground.

## Circuit Description

## Block Diagram



## Theory of Operation

The CS-5101 is designed to regulate voltages in multiple output power supplies. Functionally, it is similar to a magnetic amplifier, operating as a switch with a delayed turn-on. It can be used with both single ended and dual ended topologies.

The  $V_{FB}$  voltage is monitored by the error amplifier EA. It is compared to an internal reference voltage and the amplified differential signal is fed through an inverting amplifier into the buffer, BUF. The buffered signal is compared at the PWM comparator with the ramp voltage generated by capacitor  $C_R$ . When the ramp voltage  $V_R$  exceeds the control voltage  $V_C$ , the output of the PWM comparator goes high, latching its state through the LATCH, the output stage transistor  $Q_1$  turns on, and the external power switch, usually an N-FET, turns on.

## SYNC Function

The SYNC circuit is activated at time  $t_1$  (Figure 1) when the voltage at the SYNC pin exceeds the threshold level (2.5V) of the SYNC comparator. The external ramp capacitor  $C_R$  is allowed to charge through the internal current source  $I$  ( $200\mu A$ ). At time  $t_2$ , the ramp voltage intersects with the control voltage  $V_C$  and the output of the PWM comparator goes high, turning on the output stage and the external power switch. At the same time, the PWM comparator is latched by the RS latch, LATCH.

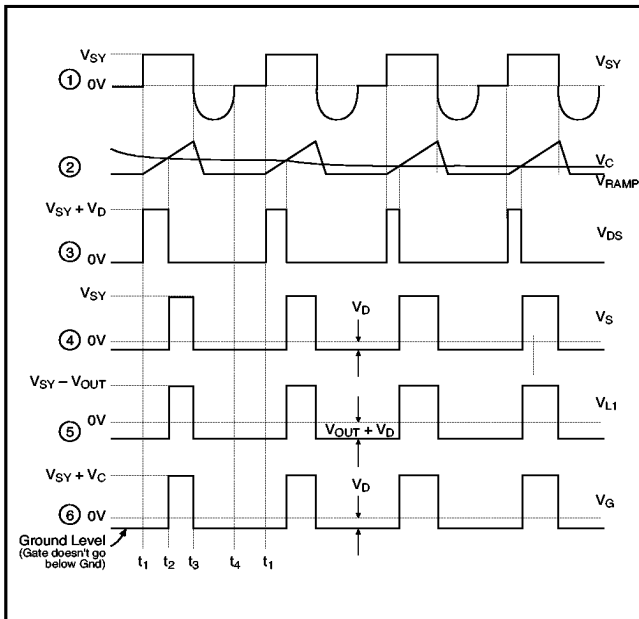


Figure 1. Waveforms for CS-5101. The number to the left of each curve refers to a node on the Application Diagram.

The logic state of the LATCH can be changed only when both the voltage level of the trailing edge of the power pulse at the SYNC pin is less than the threshold voltage of the SYNC comparator (2.5V) and the RAMP voltage is less than the threshold voltage of the RAMP comparator (1.65V). On the negative going transition of the secondary side pulse  $V_{SY}$ , gate  $G_2$  output goes high, resetting the latch at time  $t_3$ . Capacitor  $C_R$  is discharged through transistor  $Q_4$ .  $C_R$ 's output goes low disabling the output stage, and the external power switch (an N-FET) is turned off.

## RAMP Function

The value of the ramp capacitor  $C_R$  is based on the switching frequency of the regulator and the maximum duty cycle of the secondary pulse  $V_{SY}$ .

If the RAMP pin is pulled externally to 0.3V or below, the SSPR is disabled. Current drawn by the IC is reduced to less than  $100\mu A$ , and the IC is in SLEEP mode.

## FAULT Function

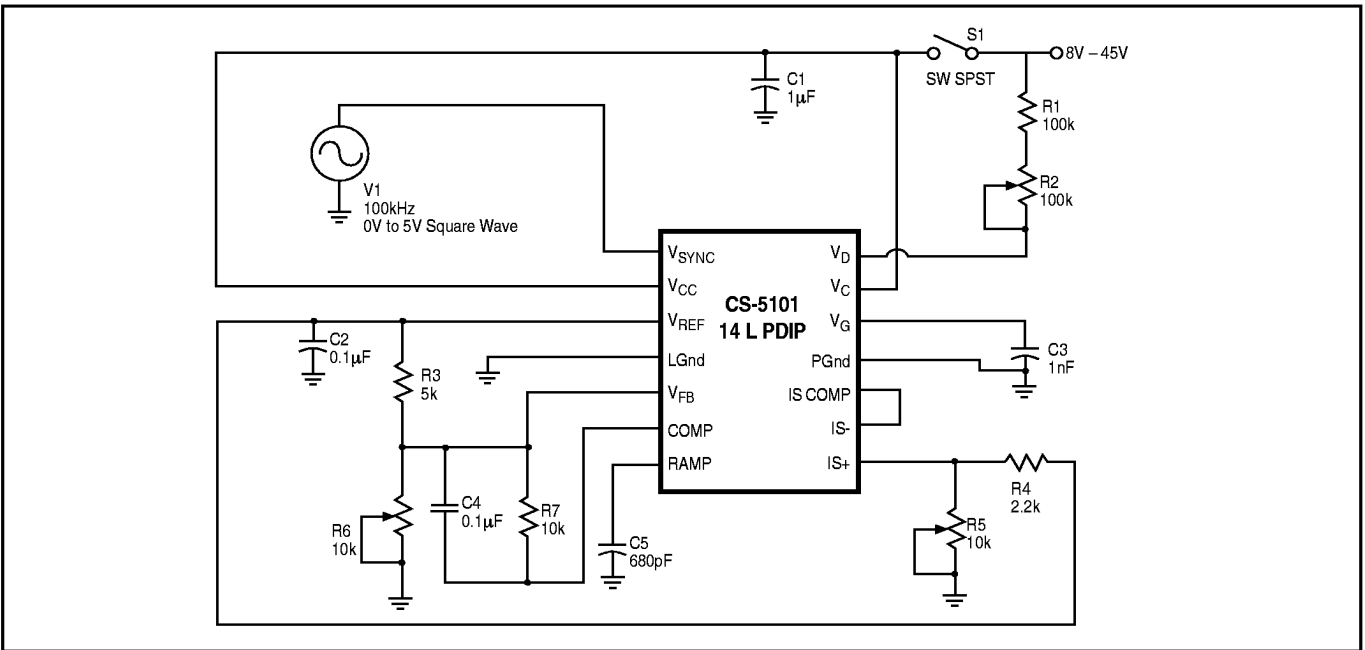
The voltage at the  $V_{CC}$  pin is monitored by the undervoltage lockout comparator with hysteresis. When  $V_{CC}$  falls below the UVL threshold, the 5V reference and all the circuitry running off of it is disabled. Under this condition the supply current is reduced to less than  $500\mu A$ .

The  $V_{CC}$  supply voltage is further monitored by the  $V_{CC\_OK}$  comparator. When  $V_{CC}$  is reduced below  $V_{REF} - 0.7V$ , a fault signal is sent to gate  $G_1$ . This fault signal, which determines if  $V_{CC}$  is absent, works in conjunction with the ramp signal to disable the output, but only after the current cycle has finished and the RS latch is reset. Therefore this fault will not cause the output to turn off during the middle of an on pulse, but rather will utilize lossless turn-off. This feature protects the FET from over-voltage stress. This is accomplished through gate  $G_1$  by driving transistor  $Q_4$  on.

An additional fault signal is derived from the REF\_OK comparator.  $V_{REF}$  is monitored so to disable the output through gate  $G_1$  when the  $V_{REF}$  voltage falls below the OK threshold. As in the  $V_{CC\_OK}$  fault, the REF\_OK fault disables the output after the current cycle has been completed. The fault logic will operate normally only when  $V_{REF}$  voltage is within the specification limits of REF\_OK.

## DRAIN Function

The drain pin,  $V_D$  monitors the voltage on the drain of the power switch and derives energy from it to keep the output stage in an off state when  $V_C$  or  $V_{CC}$  is below the minimum specified voltage.



CS-5101 bench test

**Package Specification**

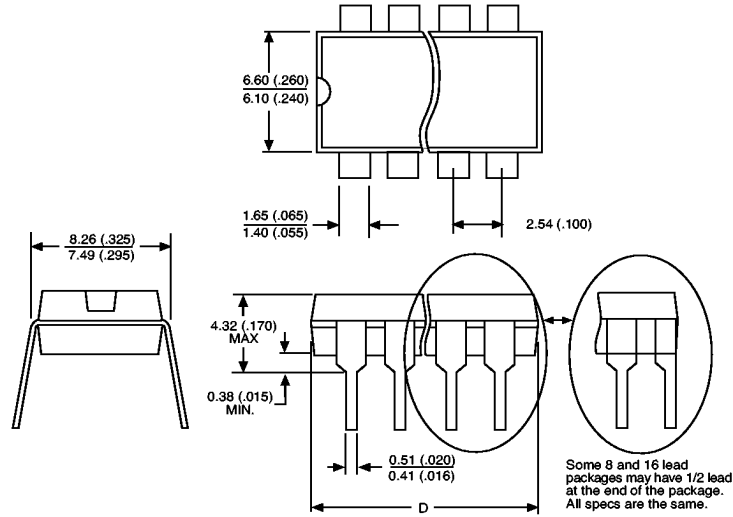
**PACKAGE DIMENSIONS IN mm (INCHES)**

Lead Count	D			
	Metric		English	
	Max	Min	Max	Min
14L PDIP	19.18	18.92	.755	.745
16L SO Wide	10.46	10.21	.412	.402

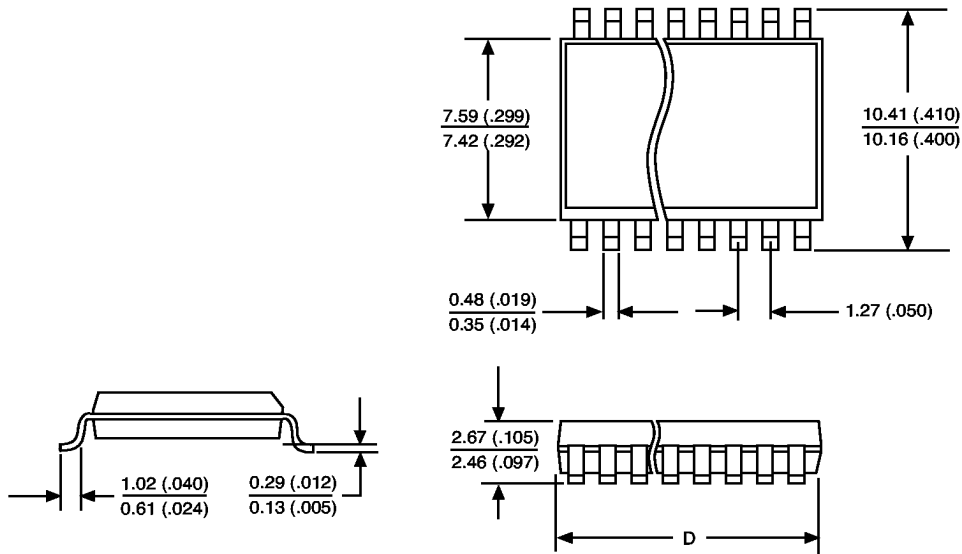
**PACKAGE THERMAL DATA**

Thermal Data		16L SOIC	14L PDIP	
R <sub>θJC</sub>	typ	23	48	°C/W
R <sub>θJA</sub>	typ	105	85	°C/W

**PDIP: 300 mil wide**



**SO Wide: 300 mil wide**



**Ordering Information**

Part Number	Description
CS-5101N14	14L PDIP
CS-5101DW16	16L SO Wide
CS-5101DWR16	16L SO Wide Tape & Reel

Cherry Semiconductor Corporation reserves the right to make changes to the specifications without notice. Please contact Cherry Semiconductor Corporation for the latest available information.

**PATENTS PENDING**